NOTES:
1. LEAK TEST: 80 PSI, NO BUBBLES 1 MINUTE MINIMUM.
2. HYPOT 630 VDC 500 MΩ 0.01 SEC MINIMUM, WIRE TO WIRE.
3. ALL TESTS ARE PERFORMED AT ROOM TEMPERATURE.
4. ALL PARTS MUST PASS ALL TESTS.
5. WIRES ARE NOT REQUIRED TO BEND SHARPLY AT EPOXY SEAL SURFACE.
6. WIRES POSITIONS IN TOP VIEW ARE REFERENCE ONLY.
7. DIMENSION IS OVER—ALL LENGTH EXCLUDING OVERFILL ON ATMOSPHERE SIDE.
8. REF—PARTS ARE DFLASHED ON PARTING LINE + 0.005 [.01] MAXIMUM.
9. NO VOIDS ARE ACCEPTABLE ON O—RING SEALING SURFACES, VOIDS SMALLER THAN 0.035 [.89] ARE ACCEPTABLE ON ALL OTHER SURFACES.
10. DIMENSIONS ARE INCHES [millimeters].